

**General Description**

The 5N60 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications.

**Features**

- 4.5A, 600V, RDS (on) = 2.5 Ω @VGS = 10 V
- 100% Avalanche Tested
- Improved dv/dt capability

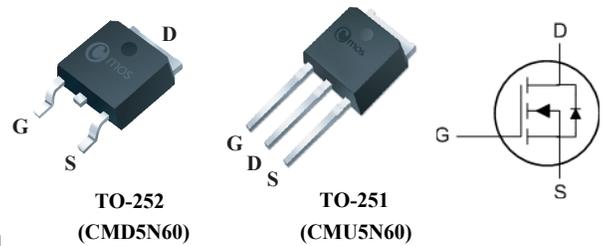
**Product Summary**

BVDSS	RDSON	ID
600V	2.5Ω	4.5A

**Applications**

- Power Supply
- PFC
- Ballast

**TO-252/251 Pin Configuration**



**Absolute Maximum Ratings**

T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>DSS</sub>	Drain-Source Voltage	600	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)	4.5	A
	- Continuous (T <sub>C</sub> = 100°C)	2.6	A
I <sub>DM</sub>	Drain Current - Pulsed <sup>a</sup>	13.5	A
V <sub>GSS</sub>	Gate-Source Voltage	± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>b</sup>	220	mJ
I <sub>AR</sub>	Avalanche Current <sup>a</sup>	4.5	A
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>a</sup>	4.9	mJ
dv/dt	Peak Diode Recovery dv/dt <sup>c</sup>	4.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)	54	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

**Thermal Characteristics**

Symbol	Parameter	Value	Units
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case Max.	2.56	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient Max.	110	°C/W

## Electrical Characteristic

$T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	600	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 480\text{ V}, T_C = 125^\circ\text{C}$	--	--	10	
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 2.25\text{ A}$	--	--	2.5	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 2.25\text{ A}^d$	--	4.7	--	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}$	--	490	--	pF
$C_{oss}$	Output Capacitance		$V_{GS} = 0\text{ V}$	--	55	--
$C_{riss}$	Reverse Transfer Capacitance	$f = 1.0\text{ MHz}$	--	10	--	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 300\text{ V}$ $I_D = 4.5\text{ A}$ $R_G = 25\ \Omega$	--	15	--	ns
$t_r$	Turn-On Rise Time		--	42	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	55	--	ns
$t_f$	Turn-Off Fall Time		--	26	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480\text{ V}$ $I_D = 4.5\text{ A}$ $V_{GS} = 10\text{ V}$	--	15	--	nC
$Q_{gs}$	Gate-Source Charge		--	2.8	--	nC
$Q_{gd}$	Gate-Drain Charge		--	7	--	nC

### Drain-Source Diode Characteristics and Maximum Ratings

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	4.5	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	13.5	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 4.5\text{ A}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 4.5\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$	--	300	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	2.2	--	$\mu\text{C}$

Notes:

- Repetitive Rating: Pulse width limited by maximum junction temperature
- $L = 18.9\text{ mH}$ ,  $I_{AS} = 4.5\text{ A}$ ,  $V_{DD} = 50\text{ V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$
- $I_{SD} \leq 4.5\text{ A}$ ,  $di/dt \leq 200\text{ A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
- Pulse Test: Pulse width  $\leq 300\ \mu\text{s}$ , Duty cycle  $\leq 2\%$
- Essentially independent of operating temperature

This product has been designed and qualified for the consumer market.

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Cmos reserves the right to improve product design, functions and reliability without notice.